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CMOS Digital Integrated Circuits Silicon Monolithic

74HC4049D,74HC4050D

1. Functional Description

・ Hex Buffer

74HC4049D: HEX BUFFER/CONVERTER (INVERTING)
74HC4050D: HEX BUFFER/CONVERTER

2. General

The 74HC4049D and 74HC4050D are high speed CMOS HEX BUFFERs fabricated with silicon gate C^2MOS technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The 74HC4049D is an inverting buffer, while the 74HC4050D is a non-inverting buffer. The internal circuits are composed of 3-stages (74HC4049D) or 2-stages (74HC4050D) of inverter, which provided high noise immunity and stable output.

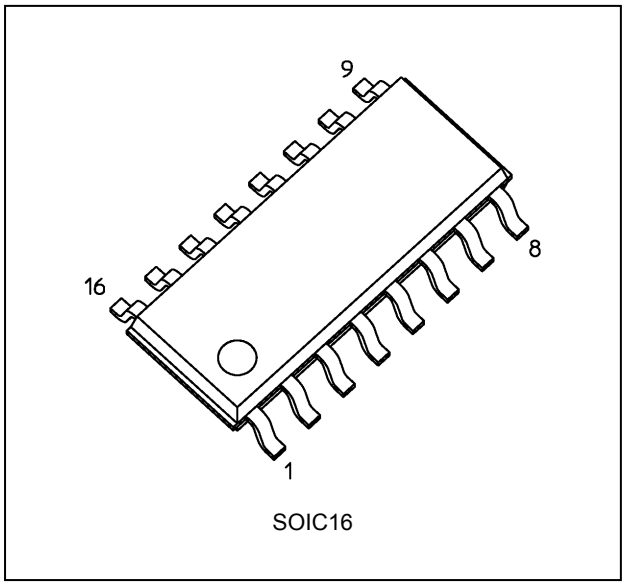
Input protection circuits are different from those of other high speed CMOS IC's. They eliminate the diodes on the V_{CC} side thus providing of logic-level conversion from high-level voltages up to 15 V to low-level voltages.

They are useful for battery back up circuits, because input voltage can be applied on IC's which are not biased by V_{CC}.

3. Features

(1) High speed: t_{pd} = 8 ns (typ.) at V_{CC} = 6.0 V
(2) Low power dissipation: I_{CC} = 1.0 μA (max) at T_a = 25 °C
(3) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
(4) Wide operating voltage range: $V_{CC(opr)}$ = 2.0 V to 6.0 V

4. Packaging

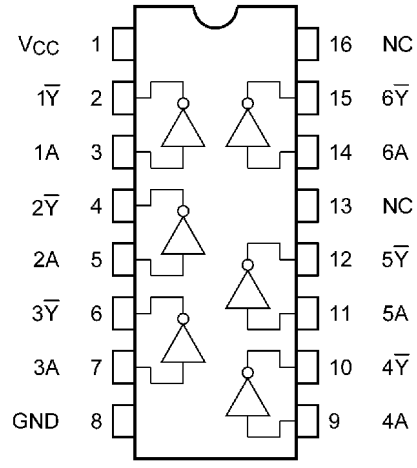


SOIC16

Start of commercial production
2016-03

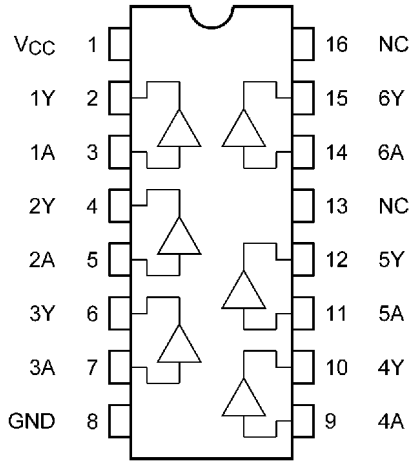
5. Pin Assignment

74HC4049D



(top view)

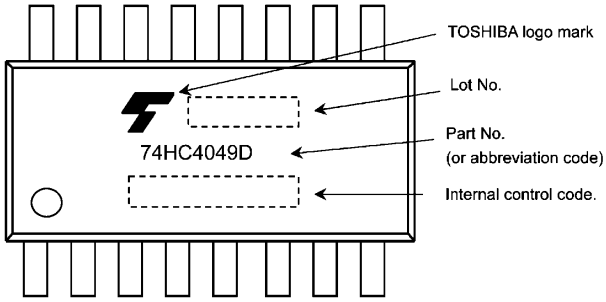
74HC4050D



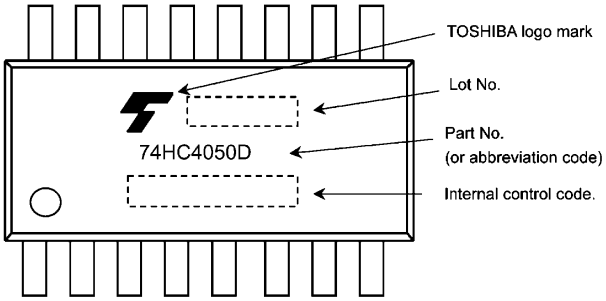
(top view)

6. Marking

74HC4049D

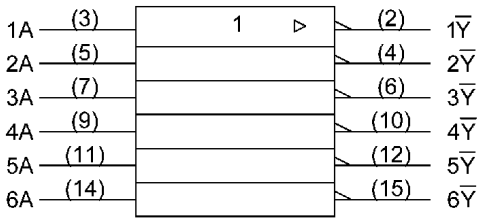


74HC4050D

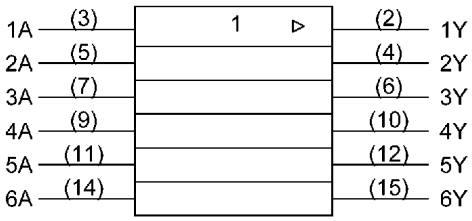


7. IEC Logic Symbol

74HC4049D



74HC4050D

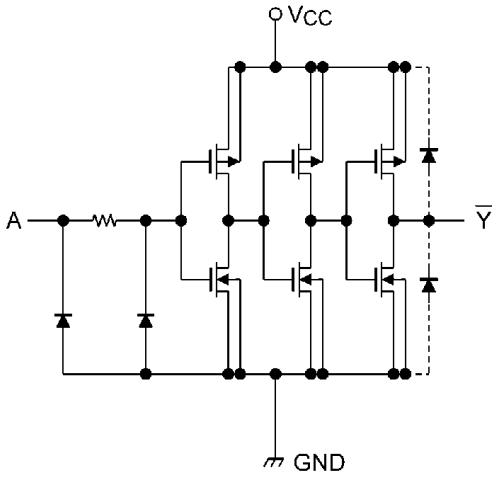


8. Truth Table

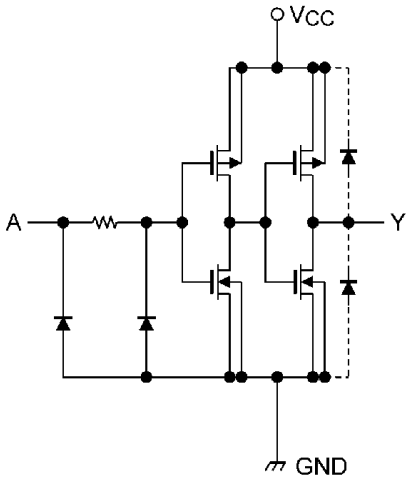
Input A	Output $\overline{Y}$ (74HC4049D)	Output Y (74HC4050D)
L	H	L
H	L	H

9. Internal Equivalent Circuit

74HC4049D



74HC4050D



10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V_{CC}		-0.5 to 7.0	V
Input voltage	V_{IN}	(Note 1)	-0.5 to 18.0	V
Output voltage	V_{OUT}		-0.5 to V_{CC} + 0.5	V
Input diode current	I_{IK}		-20	mA
Output diode current	I_{OK}		±20	mA
Output current	I_{OUT}		±35	mA
V_{CC}/ground current	I_{CC}		±75	mA
Power dissipation	P_D		500	mW
Storage temperature	T_{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: DC input voltage (V_{IN}) specified is measured to GND and is not related to V_{CC}.
Recommended operating range is 0 V to 15 V and it is possible to convert logic-levels from 15 V to 5 V or 5 V to 2 V.

11. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V_{CC}		2.0 to 6.0	V
Input voltage	V_{IN}		0 to 15.0	V
Output voltage	V_{OUT}		0 to V_{CC}	V
Operating temperature	T_{opr}		-40 to 85	°C
Input rise and fall times	t_r,t_f	V_{CC} = 2.0 V	0 to 1000	ns
		V_{CC} = 4.5 V	0 to 500	
		V_{CC} = 6.0 V	0 to 400	

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either V_{CC} or GND.

12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Typ.	Max	Unit
High-level input voltage	V_{IH}	—		2.0	1.50	—	—	V
				4.5	3.15	—	—	
				6.0	4.20	—	—	
Low-level input voltage	V_{IL}	—		2.0	—	—	0.50	V
				4.5	—	—	1.35	
				6.0	—	—	1.80	
High-level output voltage	V_{OH}	V_{IN} = V_{IH} or V_{IL}	I_{OH} = -20 μA	2.0	1.9	2.0	—	V
				4.5	4.4	4.5	—	
				6.0	5.9	6.0	—	
			I_{OH} = -6 mA	4.5	4.18	4.31	—	
			I_{OH} = -7.8 mA	6.0	5.68	5.80	—	
Low-level output voltage	V_{OL}	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 20 μA	2.0	—	0.0	0.1	V
				4.5	—	0.0	0.1	
				6.0	—	0.0	0.1	
			I_{OL} = 6 mA	4.5	—	0.17	0.26	
			I_{OL} = 7.8 mA	6.0	—	0.18	0.26	
Input leakage current	I_{IN}	V_{IN} = V_{CC} or GND		6.0	—	—	±0.1	μA
		V_{IN} = 15 V		6.0	—	—	±0.5	μA
Quiescent supply current	I_{CC}	V_{IN} = V_{CC} or GND		6.0	—	—	1.0	μA

12.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Max	Unit
High-level input voltage	V_{IH}	—		2.0	1.50	—	V
				4.5	3.15	—	
				6.0	4.20	—	
Low-level input voltage	V_{IL}	—		2.0	—	0.50	V
				4.5	—	1.35	
				6.0	—	1.80	
High-level output voltage	V_{OH}	V_{IN} = V_{IH} or V_{IL}	I_{OH} = -20 μA	2.0	1.9	—	V
				4.5	4.4	—	
				6.0	5.9	—	
			I_{OH} = -6 mA	4.5	4.13	—	
			I_{OH} = -7.8 mA	6.0	5.63	—	
Low-level output voltage	V_{OL}	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 20 μA	2.0	—	0.1	V
				4.5	—	0.1	
				6.0	—	0.1	
			I_{OL} = 6 mA	4.5	—	0.33	
			I_{OL} = 7.8 mA	6.0	—	0.33	
Input leakage current	I_{IN}	V_{IN} = V_{CC} or GND		6.0	—	±1.0	μA
		V_{IN} = 15 V		6.0	—	±5.0	μA
Quiescent supply current	I_{CC}	V_{IN} = V_{CC} or GND		6.0	—	10.0	μA

12.3. AC Characteristics (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 6 ns)

Characteristics	Symbol	Note	Test Condition	C_L (pF)	V_{CC} (V)	Min	Typ.	Max	Unit
Output transition time	t_{TLH},t_{THL}		—	50	2.0	—	25	60	ns
					4.5	—	6	12	
					6.0	—	5	10	
Propagation delay time	t_{PLH},t_{PHL}		—	50	2.0	—	30	75	ns
					4.5	—	9	15	
					6.0	—	8	13	
				150	2.0	—	45	100	
					4.5	—	14	20	
					6.0	—	12	17	
Input capacitance	C_{IN}		—			—	5	10	pF
Power dissipation capacitance	C_{PD}	(Note 1)	—			—	26	—	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

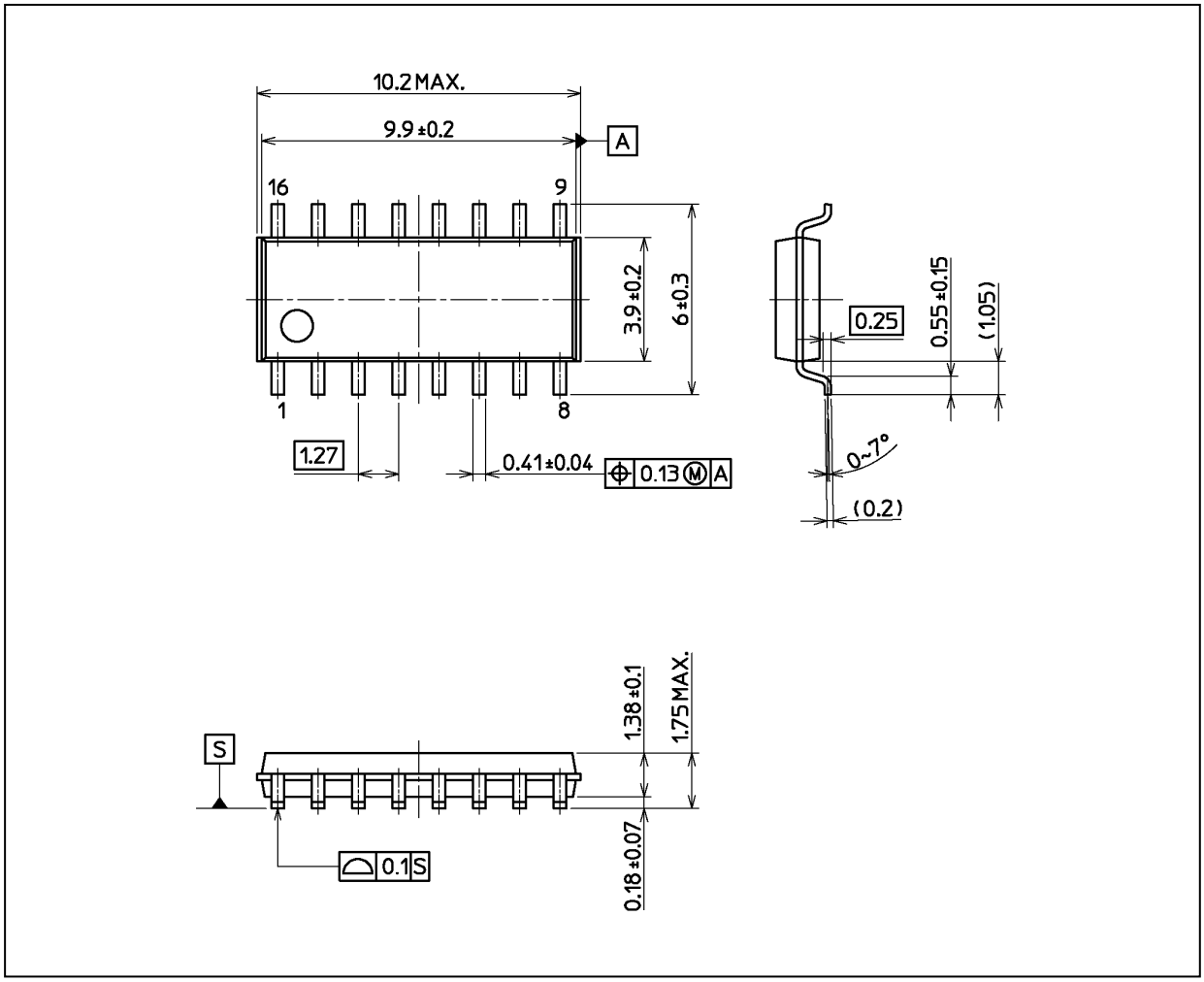
$I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/6$ (per bit)

12.4. AC Characteristics
(Unless otherwise specified, T_a = -40 to 85 °C, Input: $t_r = t_f$ = 6 ns)

Characteristics	Symbol	Test Condition	C_L (pF)	V_{CC} (V)	Min	Max	Unit
Output transition time	t_{TLH},t_{THL}	—	50	2.0	—	75	ns
				4.5	—	15	
				6.0	—	13	
Propagation delay time	t_{PLH},t_{PHL}	—	50	2.0	—	95	ns
				4.5	—	19	
				6.0	—	16	
			150	2.0	—	145	
				4.5	—	29	
				6.0	—	25	
Input capacitance	C_{IN}	—			—	10	pF

Package Dimensions

Unit: mm



Weight: 0.15 g (typ.)

Package Name(s)
Nickname: SOIC16

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